National Semiconductor

July 1989

DM54LS491/74LS491 10-Bit Counter

General Description

The ten-bit counter can count up, count down, set, and load 2 LSB's, 2 MSB's and 6 middle bits high or low as a group. All operations are synchronous with the clock. SET overrides LOAD, COUNT and HOLD. LOAD overrides COUNT. COUNT is conditional on C_{IN}, otherwise it holds.

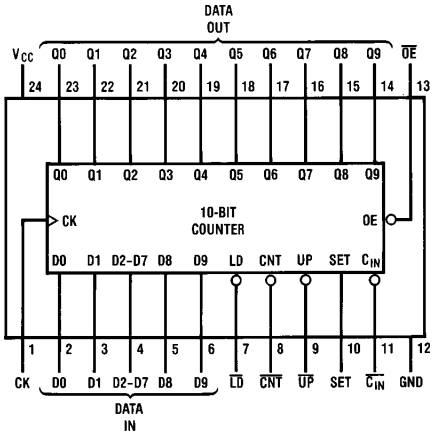
All outputs are enabled when $\overline{OE}$ is low, otherwise HIGH-Z. The 24 mA I_{OL} outputs are suitable for driving RAM/PROM address lines in video graphics systems.

Features/Benefits

- CRT vertical and horizontal timing generation
- Bus-structured pinout
- 24-pin SKINNYDIP saves space
- TRI-STATE® outputs drive bus lines
- Low current PNP inputs reduce loading

Connection Diagram

Top View



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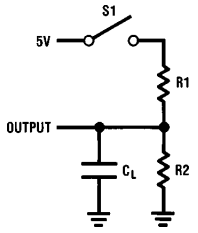
Order Number DM54LS491J, DM74LS491J or DM74LS491N
See NS Package Number J24F or N24C

Standard Test Load



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Function Table

$\overline{OE}$	CK	SET	LD	$\overline{CNT}$	$\overline{C_{IN}}$	$\overline{UP}$	D9-D0	Q9-Q0	Operation
H	X	X	X	X	X	X	X	Z	Hi-Z
L	↑	H	X	X	X	X	X	H	Set all HIGH
L	↑	L	L	X	X	X	D	D	LOAD D
L	↑	L	H	H	X	X	X	Q	HOLD
L	↑	L	H	L	H	X	X	Q	HOLD
L	↑	L	H	L	L	L	X	Q plus 1	Count UP
L	↑	L	H	L	L	H	X	Q minus 1	Count DN

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Absolute Maximum Ratings

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage V_{CC}	7V
Input Voltage	5.5V
Off-State Output Voltage	5.5V
Storage Temperature	−65° to +150°C

Operating Conditions

Symbol	Parameter		Military			Commercial			Units
			Min	Typ	Max	Min	Typ	Max	
V_{CC}	Supply Voltage		4.5	5	5.5	4.75	5	5.25	V
T_A	Operating Free-Air Temperature		−55		125*	0		75	°C
t_w	Width of Clock	High	40			40			ns
		Low	35			35			
t_{SU}	Set-Up Time		60			50			ns
t_h	Hold Time		0	−15		0	−15		

* Case temperature

Electrical Characteristics Over Operating Conditions

Symbol	Parameter	Test Conditions			Min	Typ†	Max	Units
V_{IL}	Low-Level Input Voltage						0.8	V
V_{IH}	High-Level Input Voltage				2			V
V_{IC}	Input Clamp Voltage	V_{CC} = MIN	I_I = −18 mA				−1.5	V
I_{IL}	Low-Level Input Current	V_{CC} = MAX	V_I = 0.4V				−0.25	mA
I_{IH}	High-Level Input Current	V_{CC} = MAX	V_I = 2.4V				25	μA
I_I	Maximum Input Current	V_{CC} = MAX	V_I = 5.5V				1	mA
V_{OL}	Low-Level Output Voltage	V_{CC} = MIN, V_{IL} = 0.8V, V_{IH} = 2V	MIL	I_{OL} = 12 mA			0.5	V
			COM	I_{OL} = 24 mA				
V_{OH}	High-Level Output Voltage	V_{CC} = MIN, V_{IL} = 0.8V, V_{IH} = 2V	MIL	I_{OH} = −2 mA	2.4			V
			COM	I_{OH} = 3.2 mA				
I_{OZL}	Off-State Output Current	V_{CC} = MAX, V_{IL} = 0.8V, V_{IH} = 2V		V_O = 0.4V			−100	μA
I_{OZH}				V_O = 2.4V			100	μA
I_{OS}	Output Short-Circuit Current*	V_{CC} = 5.0V		V_O = 0V	−30		−130	mA
I_{CC}	Supply Current	V_{CC} = MAX				120	180	mA

* No more than one output should be shorted at a time and duration of the short-circuit should not exceed one second.

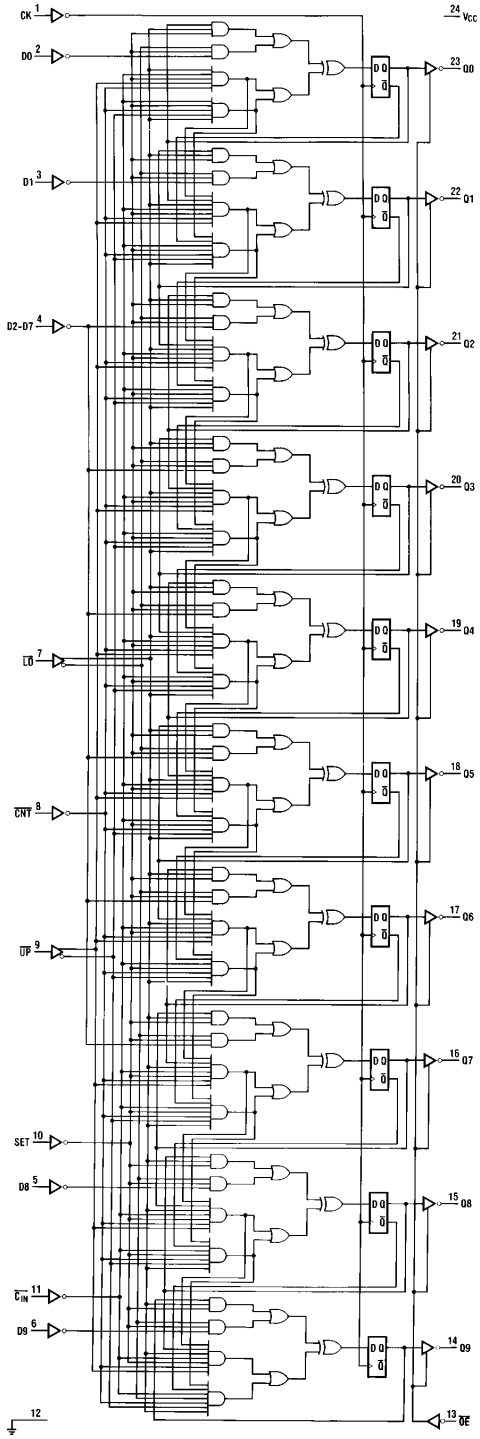
† All typical values are at V_{CC} = 5V, T_A = 25°C

Switching Characteristics Over Operating Conditions

Symbol	Parameter	Test Conditions (See Test Load)	Military			Commercial			Units
			Min	Typ	Max	Min	Typ	Max	
f_{MAX}	Maximum Clock Frequency	C_L = 50 pF, R_1 = 200Ω, R_2 = 390Ω	10.5			12.5			MHz
t_{PD}	Clock to Q			20	35		20	30	ns
t_{PZX}	Output Enable Delay			35	55		35	45	ns
t_{PXZ}	Output Disable Delay			35	55		35	45	ns

Logic Diagram

10-Bit Up/Down Counter



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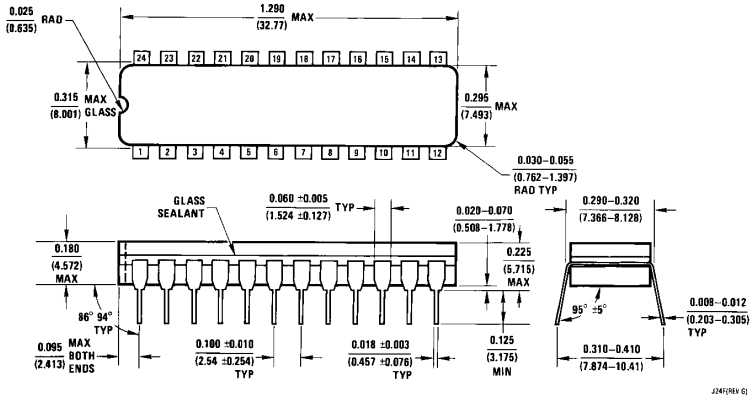
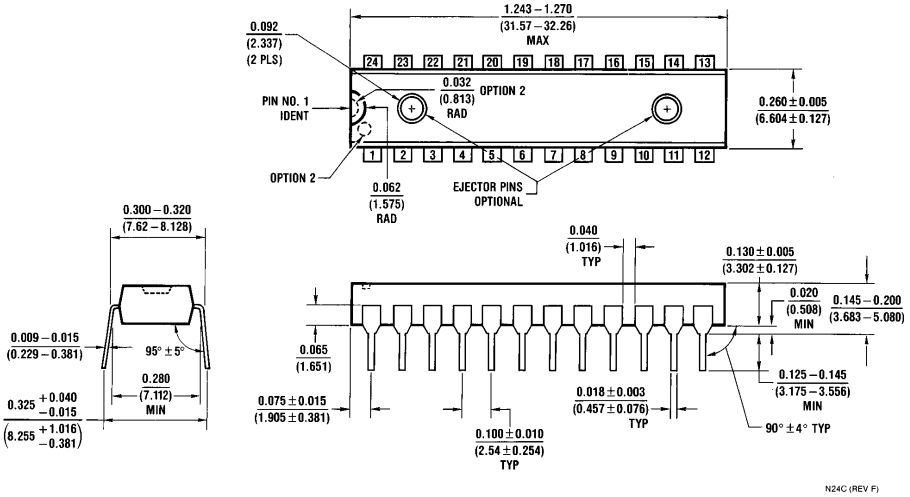
Physical Dimensions inches (millimeters)



24-Pin Narrow Ceramic Dual-In-Line Package (J)
Order Number DM54LS491J or DM74LS491J
NS Package Number J24F



24-Pin Narrow Plastic Dual-In-Line Package (N)
Order Number DM74LS491N
NS Package Number N24C

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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